



Product Change Notification / MFOL-02TISW617

Date:

04-Jul-2024

Product Category:

16-Bit - Microcontrollers And Digital Signal Controllers

PCN Type:

Manufacturing Change

Notification Subject:

CCB 6123 Final Notice: Qualification of Microchip Technology Gresham – Fab 4 (GRTM) as an additional fabrication site for selected dsPIC33EP128xx, dsPIC33EP256xx, dsPIC33EP32xx, dsPIC33EP512xx, DSPIC33EP64xx, PIC24EP128GP2xx, PIC24EP128MC2xx, PIC24EP256GP2xx, PIC24EP256MC2xx, PIC24EP32GP2xx, PIC24EP32MC2xx, PIC24EP512GP2xx, PIC24EP512MC2xx, PIC24EP64GP2xx and PIC24EP64MC2xx device families available in various packages.

Affected CPNs:

[MFOL-02TISW617_Affected_CPN_07042024.pdf](#)

[MFOL-02TISW617_Affected_CPN_07042024.csv](#)

Notification Text:

PCN Status:Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section.

Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of Microchip Technology Gresham – Fab 4 (GRTM) as an additional fabrication site for selected dsPIC33EP128xx, dsPIC33EP256xx, dsPIC33EP32xx, dsPIC33EP512xx, DSPIC33EP64xx, PIC24EP128GP2xx, PIC24EP128MC2xx, PIC24EP256GP2xx, PIC24EP256MC2xx, PIC24EP32GP2xx, PIC24EP32MC2xx, PIC24EP512GP2xx, PIC24EP512MC2xx, PIC24EP64GP2xx and PIC24EP64MC2xx device families available in various packages.

Pre and Post Change Summary:

	Pre Change		Post Change		
Fab Site	Taiwan Semiconductor Manufacturing Corp. (Fab 3)*	Taiwan Semiconductor Manufacturing Corp. (Fab 11)	Taiwan Semiconductor Manufacturing Corp. (Fab 3)*	Taiwan Semiconductor Manufacturing Corp. (Fab 11)	Microchip Technology Gresham – Fab 4 (GRTM)
Wafer Diameter	8 inch	8 inch	8 inch	8 inch	8 inch
Quality Certification	ISO-9001/ IATF16949/IATF16949	IATF16949/ISO-14001	ISO-9001/ IATF16949/IATF16949	IATF16949/ISO-14001	ISO-9001/ IATF16949/ ISO-14001

Note: *Applies only to specific products dsPIC33EP64xx and PIC24EP64xx products

Impacts to Data Sheet:None

Change Impact:None

Reason for Change:To improve on-time delivery performance by qualifying Microchip Technology Gresham – Fab 4 (GRTM) as an additional fab assembly site.

Change Implementation Status:In Progress

Estimated First Ship Date:January 31, 2024 (date code: 2405)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	March 2023					>	January 2024					>	July 2024				
Workweek	09	10	11	12	13		01	02	03	04	05		27	28	29	30	31
Initial PCN Issue Date		x															
Qual Report													x				

Availability																	
Final PCN Issue Date											X						
Estimated Implementation Date											X						

Method to Identify Change:Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History:March 9, 2023: Issued initial notification.

January 29, 2024: Issued final notification. Updated the affected parts list. Updated notification subject, description of change, and qual title accordingly. Provided estimated first ship date to be on January 31, 2024.

February 8, 2024: Re-issued final notification. Updated PCN title from initial notice to final notice.

July 4, 2024: Re-issued final notification to include the Qual Report and updated time table summary to reflect Qual Report availability. Updated the Notification subject, description of change and affected parts list to include CPNs PIC24EP256GP204T-I/MV031 and PIC24EP256GP204T-I/MV032.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

[PCN_MFOL-02TISW617_Qual Report.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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DSPIC33EP256MC204T-I/ML
DSPIC33EP256MC504T-I/ML
PIC24EP256GP204T-I/ML
PIC24EP256MC204-I/MV
DSPIC33EP256GP504-I/ML
DSPIC33EP256MC206T-I/PT
DSPIC33EP256GP504T-E/MV
DSPIC33EP256MC204T-E/MV
DSPIC33EP256MC206-I/MR
DSPIC33EP256MC506-I/MR
DSPIC33EP256MC504T-E/MV
PIC24EP256GP206-I/MR
PIC24EP256MC206-I/MR
PIC24EP256GP204-I/ML
PIC24EP256MC204-I/ML
DSPIC33EP256GP504-E/MV
DSPIC33EP256MC504-E/ML
DSPIC33EP256MC204T-I/MV
DSPIC33EP256MC504T-I/MV
PIC24EP256GP204T-I/MV
PIC24EP256MC204T-I/MV
PIC24EP256MC204-E/MV
DSPIC33EP256GP504-E/ML
DSPIC33EP256MC204-E/ML
DSPIC33EP256MC206-I/PT
PIC24EP256GP204-I/PT
DSPIC33EP256GP506-E/MR
DSPIC33EP256MC206-E/MR
DSPIC33EP256MC506-E/MR
PIC24EP256GP206-E/MR
DSPIC33EP256MC204T-E/MLC02
PIC24EP256MC206T-I/MR
DSPIC33EP256GP504T-I/MV
DSPIC33EP256MC204-E/MV
DSPIC33EP256MC504-E/MV
PIC24EP256GP204-E/MV
PIC24EP256GP206T-I/MR
DSPIC33EP256MC504-I/MV
PIC24EP256GP204-I/MV
PIC24EP256GP204T-E/MV
PIC24EP256MC204T-E/MV
DSPIC33EP256GP504T-E/ML
PIC24EP256GP204-E/ML
PIC24EP256MC204-E/ML
DSPIC33EP256MC206-E/PT
DSPIC33EP256GP506-I/MR

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DSPIC33EP256MC504T-E/ML
PIC24EP256GP204T-E/ML
PIC24EP256MC204T-E/ML
DSPIC33EP256MC206T-E/PT
PIC24EP256GP204-E/PT
DSPIC33EP256GP504-I/MV
DSPIC33EP256MC204-I/MV
DSPIC33EP256MC204T-E/ML
DSPIC33EP256GP504T-I/ML
PIC24EP256MC204T-I/ML
PIC24EP256GP204T-I/PT
PIC24EP256GP204T-I/ML029
PIC24EP256GP204T-I/MV030
PIC24EP256GP206-E/PT
PIC24EP256GP206-I/PT
PIC24EP256GP206T-I/PT
PIC24EP256GP206T-E/PT
DSPIC33EP256MC506T-E/PT
DSPIC33EP256GP504-E/PT
DSPIC33EP256MC204-E/PT
PIC24EP256MC204-E/PT
DSPIC33EP256GP504-I/PT
PIC24EP256GP202T-E/MM
DSPIC33EP256MC204-I/PT
DSPIC33EP256MC504-I/PT
PIC24EP256MC204-I/PT
PIC24EP256MC204T-I/PT
DSPIC33EP256GP502-E/MM
DSPIC33EP256MC502-E/MM
PIC24EP256GP202-E/MM
DSPIC33EP256GP502-E/SP
DSPIC33EP256MC202-E/SP
DSPIC33EP256MC502-E/SS
PIC24EP256GP202-E/SS
DSPIC33EP256GP502-I/MM
DSPIC33EP256MC202-I/MM
DSPIC33EP256MC502-I/MM
PIC24EP256GP202-I/MM
PIC24EP256MC202-I/MM
DSPIC33EP256GP502-I/SP
DSPIC33EP256MC502-I/SP
PIC24EP256GP202-I/SP
DSPIC33EP256GP502-I/SS
DSPIC33EP256MC202-I/SS
DSPIC33EP256MC502-I/SS
PIC24EP256GP202-I/SS
PIC24EP256MC202-I/SS

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DSPIC33EP256MC506-I/PT
DSPIC33EP256GP502-I/SO
DSPIC33EP256MC202-I/SO
DSPIC33EP256MC502-I/SO
PIC24EP256GP202-I/SO
PIC24EP256MC202-I/SO
PIC24EP256MC206-I/PT
DSPIC33EP256MC506T-I/PT
PIC24EP256MC206T-I/PT
DSPIC33EP256GP502T-I/MM
PIC24EP256GP202T-I/MM
DSPIC33EP256GP502T-I/SS
PIC24EP256GP202T-I/SS
DSPIC33EP256GP504T-H/MV
DSPIC33EP256MC204T-H/MV
DSPIC33EP256MC504T-H/MV
PIC24EP256GP204T-H/MV
PIC24EP256MC204T-H/MV
DSPIC33EP256GP504T-H/ML
DSPIC33EP256MC204T-H/ML
DSPIC33EP256MC504T-H/ML
PIC24EP256GP204T-H/ML
PIC24EP256MC204T-H/ML
DSPIC33EP256GP504T-H/PT
DSPIC33EP256MC204T-H/PT
DSPIC33EP256MC504T-H/PT
PIC24EP256GP204T-H/PT
PIC24EP256MC204T-H/PT
DSPIC33EP256MC206T-H/PT
DSPIC33EP256MC506T-H/PT
PIC24EP256MC202-H/SS
DSPIC33EP256GP506-H/MR
DSPIC33EP256GP504-H/MV
DSPIC33EP256MC204-H/MV
DSPIC33EP256MC504-H/MV
PIC24EP256GP204-H/MV
PIC24EP256MC204-H/MV
DSPIC33EP256GP504-H/ML
DSPIC33EP256MC204-H/ML
DSPIC33EP256MC504-H/ML
PIC24EP256GP204-H/ML
PIC24EP256MC204-H/ML
DSPIC33EP256MC206-H/PT
DSPIC33EP256MC506-H/PT
PIC24EP256GP204T-I/MV031
PIC24EP256GP204T-I/MV032
DSPIC33EP512GP502-E/MM

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DSPIC33EP512MC206T-I/MR
DSPIC33EP512MC506T-I/MR
DSPIC33EP512GP502T-I/MM
DSPIC33EP512GP502T-I/SO
DSPIC33EP512GP506T-I/MR
PIC24EP512GP204T-I/MV
DSPIC33EP512MC504T-I/MV
DSPIC33EP512MC204T-I/MV
DSPIC33EP512GP504T-I/MV
PIC24EP512MC206T-I/MR
DSPIC33EP512MC204-I/ML
PIC24EP512GP204T-I/ML
DSPIC33EP512MC504T-I/ML
PIC24EP512GP204-I/ML
DSPIC33EP512GP506-I/MR
DSPIC33EP512MC504-I/ML
DSPIC33EP512MC502-I/SP
DSPIC33EP512MC504-I/PT
PIC24EP512GP202-I/SP
PIC24EP512MC202-I/SP
PIC24EP512MC204-E/MV
DSPIC33EP512MC502T-E/MM
DSPIC33EP512GP502T-E/MM
DSPIC33EP512MC204-I/PT
DSPIC33EP512GP504-E/ML
PIC24EP512GP206T-I/MR
DSPIC33EP512GP506T-I/PT
PIC24EP512GP204T-I/PT
PIC24EP512MC204T-I/ML
DSPIC33EP512GP502-E/SP
PIC24EP512GP202-E/MM
DSPIC33EP512MC202-E/SP
PIC24EP512GP202-I/MM
DSPIC33EP512GP502-I/SO
DSPIC33EP512GP504-I/PT
PIC24EP512GP204T-E/ML
DSPIC33EP512MC202-I/MM
DSPIC33EP512MC206-I/PT
DSPIC33EP512MC502-I/MM
DSPIC33EP512GP506-I/PT
DSPIC33EP512MC202-I/SO
DSPIC33EP512MC502-I/SO
PIC24EP512MC204-I/ML
PIC24EP512GP202-E/SP
PIC24EP512MC202-E/SP
PIC24EP512MC204T-E/ML
PIC24EP512MC206T-E/MR

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DSPIC33EP512MC206T-E/MR
DSPIC33EP512MC502-E/SO
PIC24EP512GP202-E/SO
DSPIC33EP512GP506-E/MR
DSPIC33EP512MC204T-I/ML
DSPIC33EP512GP504T-I/ML
PIC24EP512MC204T-I/MV
DSPIC33EP512GP506T-E/MR
PIC24EP512MC206-I/PT
PIC24EP512GP206-I/PT
DSPIC33EP512GP504-I/ML
DSPIC33EP512MC206-I/MR
PIC24EP512GP204-I/PT
PIC24EP512GP202-I/SO
PIC24EP512MC202-I/SO
DSPIC33EP512GP502-I/MM
DSPIC33EP512MC506-I/PT
DSPIC33EP512MC506-I/MR
PIC24EP512MC204-I/MV
DSPIC33EP512MC202-I/SP
DSPIC33EP512MC206-E/MR
PIC24EP512GP206-E/MR
PIC24EP512MC206-E/MR
DSPIC33EP512MC204T-E/MV
DSPIC33EP512GP504T-E/MV
PIC24EP512MC202-I/MM
PIC24EP512MC204-I/PT
DSPIC33EP512GP502-I/SP
DSPIC33EP512MC506-E/MR
DSPIC33EP512MC504T-E/ML
DSPIC33EP512MC204T-E/ML
DSPIC33EP512MC504T-E/MV
DSPIC33EP512GP504-E/MV
DSPIC33EP512MC204-E/MV
DSPIC33EP512MC504-E/MV
PIC24EP512GP206-E/PT
DSPIC33EP512GP504-E/PT
DSPIC33EP512MC504-E/PT
PIC24EP512MC204-E/ML
DSPIC33EP512MC502-E/SP
PIC24EP512GP206-I/MR
PIC24EP512MC206-I/MR
PIC24EP512GP204-I/MV
DSPIC33EP512MC504-I/MV
PIC24EP512GP204-E/MV
DSPIC33EP512GP504-I/MV
DSPIC33EP512GP506-E/PT

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DSPIC33EP512MC204-E/ML
DSPIC33EP512MC504-E/ML
PIC24EP512GP204-E/ML
DSPIC33EP512MC204-I/MV
DSPIC33EP512GP506-H/MR
DSPIC33EP512MC206-H/MR
DSPIC33EP512MC506-H/MR
PIC24EP512GP206-H/MR
PIC24EP512MC206-H/MR
DSPIC33EP512GP504-H/MV
DSPIC33EP512MC204-H/MV
DSPIC33EP512MC504-H/MV
PIC24EP512GP204-H/MV
PIC24EP512MC204-H/MV
DSPIC33EP512GP504-H/ML
DSPIC33EP512MC204-H/ML
DSPIC33EP512MC504-H/ML
PIC24EP512GP204-H/ML
PIC24EP512MC204-H/ML
DSPIC33EP512GP504-H/PT
DSPIC33EP512MC204-H/PT
DSPIC33EP512MC504-H/PT
PIC24EP512GP204-H/PT
PIC24EP512MC204-H/PT
DSPIC33EP512GP506-H/PT
DSPIC33EP512MC206-H/PT
DSPIC33EP512MC506-H/PT
PIC24EP512GP206-H/PT
PIC24EP512MC206-H/PT
DSPIC33EP512GP502T-H/MM
DSPIC33EP512MC202T-H/MM
DSPIC33EP512MC502T-H/MM
PIC24EP512GP202T-H/MM
PIC24EP512MC202T-H/MM
DSPIC33EP512GP506T-H/MR
DSPIC33EP512MC206T-H/MR
DSPIC33EP512MC506T-H/MR
PIC24EP512GP206T-H/MR
PIC24EP512MC206T-H/MR
DSPIC33EP512GP504T-H/MV
DSPIC33EP512MC204T-H/MV
DSPIC33EP512MC504T-H/MV
PIC24EP512GP204T-H/MV
PIC24EP512MC204T-H/MV
DSPIC33EP512GP504T-H/ML
DSPIC33EP512MC204T-H/ML
DSPIC33EP512MC504T-H/ML

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DSPIC33EP512GP504T-H/PT
DSPIC33EP512MC204T-H/PT
DSPIC33EP512MC504T-H/PT
PIC24EP512GP204T-H/PT
PIC24EP512MC204T-H/PT
PIC24EP512MC206T-H/PT
DSPIC33EP512GP506T-H/PT
DSPIC33EP512MC206T-H/PT
DSPIC33EP512MC506T-H/PT
PIC24EP512GP206T-H/PT
DSPIC33EP512GP502-H/MM
DSPIC33EP512MC202-H/MM
DSPIC33EP512MC502-H/MM
PIC24EP512GP202-H/MM
PIC24EP512MC202-H/MM
DSPIC33EP512GP502-H/SP
DSPIC33EP512MC502-H/SP
PIC24EP512MC202-H/SO
PIC24EP128GP202T-I/MM038
PIC24EP128GP202-I/MM038
PIC24EP128GP202-E/MM
DSPIC33EP128MC502T-E/MM
DSPIC33EP128MC502T-E/SS
PIC24EP128GP202T-E/SS
DSPIC33EP128GP504T-E/ML
DSPIC33EP128MC204T-E/ML
DSPIC33EP128MC504T-E/ML
DSPIC33EP128MC206T-E/PT
DSPIC33EP128MC202T-E/MM
DSPIC33EP128GP506T-I/PT
DSPIC33EP128MC206-E/PT
PIC24EP128GP204T-I/PT037
PIC24EP128GP204-I/PT030
PIC24EP128GP204-I/PT035
PIC24EP128GP204-I/PT037
PIC24EP128GP204T-I/PT030
PIC24EP128GP204T-I/PT032
PIC24EP128GP204T-I/PT035
DSPIC33EP128GP502T-E/MM
DSPIC33EP128GP502-I/SO
DSPIC33EP128GP504-E/MV
PIC24EP128GP204-E/MV
PIC24EP128GP204-E/PT
PIC24EP128GP204-I/MV
PIC24EP128GP206T-I/MR
DSPIC33EP128GP504T-I/MV
PIC24EP128GP204T-I/MV

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DSPIC33EP128GP504T-E/MV
PIC24EP128GP204T-E/MV
DSPIC33EP128MC204T-I/MV
DSPIC33EP128MC504T-I/MV
PIC24EP128MC204T-I/MV
DSPIC33EP128MC204T-I/ML
DSPIC33EP128MC504T-I/ML
PIC24EP128MC204T-I/ML
DSPIC33EP128MC204T-I/PT
PIC24EP128GP204T-I/PT
DSPIC33EP128MC206T-I/PT
DSPIC33EP128MC506T-I/PT
DSPIC33EP128GP502-E/SS
PIC24EP128MC206-E/MR
DSPIC33EP128MC502-E/SS
PIC24EP128GP206T-I/PT
DSPIC33EP128MC204T-E/MV
DSPIC33EP128MC504T-E/MV
PIC24EP128MC204T-E/MV
DSPIC33EP128MC202-E/SO
DSPIC33EP128MC206-E/MR
DSPIC33EP128MC506-E/MR
DSPIC33EP128MC204-E/MV
DSPIC33EP128MC504-E/MV
PIC24EP128MC204-E/MV
DSPIC33EP128GP504-E/ML
DSPIC33EP128MC204-E/ML
DSPIC33EP128MC504-E/ML
PIC24EP128MC204-E/ML
DSPIC33EP128MC204-E/PT
DSPIC33EP128MC504-E/PT
DSPIC33EP128MC506-E/PT
DSPIC33EP128GP506-E/PT
DSPIC33EP128GP502-I/MM
DSPIC33EP128MC202-I/MM
DSPIC33EP128MC502-I/MM
PIC24EP128GP202-I/MM
DSPIC33EP128GP502-I/SP
DSPIC33EP128MC202-I/SP
DSPIC33EP128MC502-I/SP
PIC24EP128GP202-I/SP
PIC24EP128MC202-I/SP
DSPIC33EP128GP502-I/SS
DSPIC33EP128MC202-I/SS
DSPIC33EP128MC502-I/SS
PIC24EP128GP202-I/SS
PIC24EP128MC202-I/SS

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PIC24EP128GP202-I/SO
PIC24EP128MC202-I/SO
DSPIC33EP128GP506-I/MR
DSPIC33EP128MC206-I/MR
DSPIC33EP128MC506-I/MR
PIC24EP128GP206-I/MR
PIC24EP128MC206-I/MR
DSPIC33EP128GP504-I/MV
DSPIC33EP128MC204-I/MV
DSPIC33EP128MC504-I/MV
PIC24EP128MC204-I/MV
DSPIC33EP128GP504-I/ML
DSPIC33EP128MC204-I/ML
DSPIC33EP128MC504-I/ML
PIC24EP128GP204-I/ML
PIC24EP128MC204-I/ML
DSPIC33EP128GP504-I/PT
DSPIC33EP128MC204-I/PT
DSPIC33EP128MC504-I/PT
PIC24EP128GP204-I/PT
PIC24EP128MC204-I/PT
DSPIC33EP128GP506-I/PT
DSPIC33EP128MC206-I/PT
DSPIC33EP128MC506-I/PT
PIC24EP128GP206-I/PT
PIC24EP128MC206-I/PT
DSPIC33EP128GP502T-I/MM
DSPIC33EP128MC202T-I/MM
DSPIC33EP128MC502T-I/MM
DSPIC33EP128MC202T-I/SS
PIC24EP128GP202T-I/SS
DSPIC33EP128GP506T-I/MR
DSPIC33EP128MC206T-I/MR
DSPIC33EP128MC506T-I/MR
PIC24EP128MC206T-I/MR
PIC24EP128GP204-I/PT039
PIC24EP128GP204T-I/PT039
DSPIC33EP128MC206T-H/MR
DSPIC33EP128MC204T-H/MV
DSPIC33EP128GP504T-H/MV
DSPIC33EP128MC504T-H/MV
PIC24EP128GP204T-H/MV
PIC24EP128MC204T-H/MV
DSPIC33EP128MC504T-H/ML
DSPIC33EP128GP506-H/MR
DSPIC33EP128MC206-H/MR
DSPIC33EP128MC506-H/MR

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DSPIC33EP128GP504-H/MV
DSPIC33EP128MC204-H/MV
DSPIC33EP128MC504-H/MV
PIC24EP128GP204-H/MV
PIC24EP128MC204-H/MV
DSPIC33EP128GP504-H/ML
DSPIC33EP128MC204-H/ML
DSPIC33EP128MC504-H/ML
PIC24EP128GP204-H/ML
PIC24EP128MC204-H/ML
DSPIC33EP128GP504-H/PT
DSPIC33EP128MC204-H/PT
DSPIC33EP128MC504-H/PT
PIC24EP128GP204-H/PT
PIC24EP128MC204-H/PT
DSPIC33EP128GP506-H/PT
DSPIC33EP128MC206-H/PT
DSPIC33EP128MC506-H/PT
PIC24EP128GP206-H/PT
PIC24EP128MC206-H/PT
DSPIC33EP32MC204-E/PTA8
PIC24EP32MC202-E/MM021
PIC24EP32GP203-E/M5
PIC24EP32MC203-E/M5
DSPIC33EP32GP503-E/M5
DSPIC33EP32MC503-E/M5
PIC24EP32GP203-I/M5
PIC24EP32MC203-I/M5
DSPIC33EP32GP503-I/M5
DSPIC33EP32MC503-I/M5
DSPIC33EP32GP502T-E/MM
DSPIC33EP32MC502T-E/MM
PIC24EP32GP202T-E/MM
DSPIC33EP32GP502-E/SP
DSPIC33EP32MC202-E/SP
PIC24EP32GP202T-I/SS
DSPIC33EP32MC502-E/SS
PIC24EP32GP202-E/SS
PIC24EP32MC202-E/SS
DSPIC33EP32GP502-I/MM
DSPIC33EP32GP502-E/MM
DSPIC33EP32MC502-E/MM
PIC24EP32GP202-E/MM
PIC24EP32MC202-E/MM
PIC24EP32GP202-E/SP
PIC24EP32MC202-E/SP
DSPIC33EP32MC504-I/ML

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DSPIC33EP32GP504-I/ML
DSPIC33EP32MC204-I/ML
DSPIC33EP32GP504-I/PT
DSPIC33EP32MC204-I/PT
PIC24EP32MC204-I/PT
DSPIC33EP32MC204T-I/PT
DSPIC33EP32MC504T-I/ML
PIC24EP32GP204T-I/ML
PIC24EP32MC204T-I/ML
DSPIC33EP32GP504T-I/PT
DSPIC33EP32MC202T-I/SO
DSPIC33EP32MC502T-I/SO
PIC24EP32GP202T-I/SO
DSPIC33EP32MC502T-E/SS
PIC24EP32GP202T-E/SS
PIC24EP32MC202T-E/SS
PIC24EP32MC204T-I/MV
DSPIC33EP32GP504T-I/ML
DSPIC33EP32MC204T-I/ML
DSPIC33EP32GP502T-E/SO
DSPIC33EP32MC502T-E/SO
PIC24EP32GP202T-E/SO
DSPIC33EP32GP504T-E/MV
DSPIC33EP32MC204T-E/MV
DSPIC33EP32MC504T-E/MV
PIC24EP32GP204T-E/MV
PIC24EP32MC204T-E/MV
DSPIC33EP32GP504T-E/ML
DSPIC33EP32MC204T-E/ML
DSPIC33EP32MC504T-E/ML
DSPIC33EP32MC204T-E/PT
DSPIC33EP32GP502-E/SO
DSPIC33EP32MC504T-I/MV
PIC24EP32GP204T-I/MV
PIC24EP32GP204T-E/ML
PIC24EP32MC204T-E/ML
DSPIC33EP32GP504T-E/PT
DSPIC33EP32GP504T-I/MV
DSPIC33EP32MC204T-I/MV
DSPIC33EP32MC502-I/MM
PIC24EP32MC202-I/MM
DSPIC33EP32GP502-I/SP
DSPIC33EP32MC502-I/SS
DSPIC33EP32MC502-I/SP
PIC24EP32GP202-I/SP
PIC24EP32MC202-I/SP
DSPIC33EP32MC202-I/SP

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DSPIC33EP32MC502-E/SO
PIC24EP32GP202-E/SO
DSPIC33EP32GP504-E/MV
DSPIC33EP32MC204-E/MV
DSPIC33EP32MC504-E/MV
DSPIC33EP32GP504-E/PT
DSPIC33EP32MC204-E/PT
PIC24EP32MC202-E/SO
PIC24EP32MC202-I/SO
DSPIC33EP32GP504-I/MV
DSPIC33EP32MC204-I/MV
DSPIC33EP32MC504-I/MV
PIC24EP32GP204-I/MV
DSPIC33EP32GP502-I/SO
DSPIC33EP32MC502-I/SO
DSPIC33EP32MC202-I/SO
DSPIC33EP32GP502T-I/SO
PIC24EP32GP204-E/MV
DSPIC33EP32GP504-E/ML
DSPIC33EP32MC204-E/ML
DSPIC33EP32MC504-E/ML
PIC24EP32GP204-E/ML
PIC24EP32MC204-E/ML
PIC24EP32GP202-I/SO
PIC24EP32MC202-I/SS
DSPIC33EP32GP502T-I/MM
DSPIC33EP32MC502T-I/MM
PIC24EP32GP202T-I/MM
PIC24EP32GP202-I/SS
PIC24EP32MC204-E/MV
PIC24EP32GP202-I/MM
PIC24EP32MC202T-E/MM021
DSPIC33EP32MC202-I/MM
DSPIC33EP32MC202T-I/MM
DSPIC33EP32MC202T-E/MM
DSPIC33EP32MC202-E/MM
PIC24EP32GP204T-E/PT
DSPIC33EP32MC504-E/PT
DSPIC33EP32MC504-I/PT
DSPIC33EP32MC504T-I/PT
PIC24EP32GP204-E/PT
PIC24EP32GP204-I/PT
PIC24EP32GP204T-I/PT
DSPIC33EP32MC202-I/SS
DSPIC33EP32MC202T-I/SS
DSPIC33EP32MC202T-E/SS
DSPIC33EP32MC202-E/SS

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DSPIC33EP32GP502T-I/SS
DSPIC33EP32GP502T-E/SS
PIC24EP32MC202T-E/MM023
DSPIC33EP32GP504T-H/MV
DSPIC33EP32MC204T-H/MV
DSPIC33EP32MC504T-H/MV
PIC24EP32GP204T-H/MV
PIC24EP32MC204T-H/MV
DSPIC33EP32GP504T-H/ML
DSPIC33EP32MC204T-H/ML
DSPIC33EP32MC504T-H/ML
PIC24EP32GP204T-H/ML
PIC24EP32MC204T-H/ML
DSPIC33EP32GP504T-H/PT
DSPIC33EP32MC204T-H/PT
DSPIC33EP32MC504T-H/PT
PIC24EP32GP204T-H/PT
PIC24EP32MC204T-H/PT
DSPIC33EP32MC202-H/MM
DSPIC33EP32GP504-H/MV
DSPIC33EP32MC204-H/MV
DSPIC33EP32MC504-H/MV
PIC24EP32GP204-H/MV
PIC24EP32MC204-H/MV
PIC24EP32GP203-H/M5
PIC24EP32MC203-H/M5
DSPIC33EP32GP503-H/M5
DSPIC33EP32MC503-H/M5
DSPIC33EP32MC204-H/PT
PIC24EP64GP204-I/PTC03
DSPIC33EP64MC204-I/PTC02
PIC24EP64MC203-I/M5
DSPIC33EP64GP503-I/M5
DSPIC33EP64MC503-I/M5
DSPIC33EP64MC203-I/M5
PIC24EP64MC203-E/M5
DSPIC33EP64GP503-E/M5
DSPIC33EP64MC503-E/M5
DSPIC33EP64MC203-E/M5
PIC24EP64GP203-I/M5
PIC24EP64GP203-E/M5
PIC24EP64GP204-E/PT
DSPIC33EP64GP506-E/PT
PIC24EP64GP206-E/PT
DSPIC33EP64GP502-I/MM
DSPIC33EP64GP502-E/MM
PIC24EP64GP202-E/MM

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DSPIC33EP64GP502-I/SP
PIC24EP64GP202-I/SP
DSPIC33EP64GP502-E/SO
PIC24EP64GP202-I/SS
PIC24EP64GP202-E/SO
DSPIC33EP64GP506-E/MR
PIC24EP64GP206-E/MR
DSPIC33EP64GP504-I/PT
PIC24EP64GP204-I/PT
PIC24EP64GP204-I/MV
DSPIC33EP64GP504-I/ML
PIC24EP64GP204-I/ML
DSPIC33EP64GP504-E/MV
PIC24EP64GP204-E/MV
DSPIC33EP64GP506-I/PT
PIC24EP64GP206-I/PT
DSPIC33EP64GP504-E/ML
PIC24EP64GP204-E/ML
DSPIC33EP64GP504-E/PT
PIC24EP64GP202-I/SO
DSPIC33EP64GP506-I/MR
PIC24EP64GP206-I/MR
DSPIC33EP64GP502-I/SO
DSPIC33EP64GP504-I/MV
DSPIC33EP64GP502T-I/SO
DSPIC33EP64GP506T-I/MR
PIC24EP64GP206T-I/MR
DSPIC33EP64GP504T-I/MV
DSPIC33EP64GP504T-I/ML
PIC24EP64GP202T-I/MM
PIC24EP64GP202T-I/SS
DSPIC33EP64MC206-E/PTA8
DSPIC33EP64GP504T-E/MV
PIC24EP64GP204T-E/MV
DSPIC33EP64GP504T-E/ML
PIC24EP64GP204T-E/ML
PIC24EP64GP206T-E/MR
PIC24EP64GP204T-I/ML
PIC24EP64GP204T-I/PT
DSPIC33EP64GP502T-E/MM
DSPIC33EP64GP506T-E/MR
PIC24EP64MC204-I/PTC06
DSPIC33EP64MC204T-E/PT
PIC24EP64MC202-E/SP
DSPIC33EP64MC202-E/SS
DSPIC33EP64MC502-E/SS
PIC24EP64MC202-E/SS

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PIC24EP64MC202-E/SO
DSPIC33EP64MC206-E/MR
DSPIC33EP64MC506-E/MR
PIC24EP64MC206-E/MR
DSPIC33EP64MC504T-E/PT
PIC24EP64MC204T-E/PT
DSPIC33EP64MC206T-E/PT
DSPIC33EP64MC506T-E/PT
PIC24EP64MC206T-E/PT
DSPIC33EP64MC202-I/SO
DSPIC33EP64MC502-I/SO
PIC24EP64MC202-I/SO
DSPIC33EP64MC206-I/MR
DSPIC33EP64MC506-I/MR
DSPIC33EP64MC202-E/MM
DSPIC33EP64MC502-E/MM
PIC24EP64MC202-E/MM
DSPIC33EP64MC202-E/SP
DSPIC33EP64MC502-E/SP
DSPIC33EP64MC502T-I/SO
PIC24EP64MC202T-I/SO
DSPIC33EP64MC206T-I/MR
DSPIC33EP64MC506T-I/MR
PIC24EP64MC206T-I/MR
DSPIC33EP64MC204-E/MV
PIC24EP64MC202T-E/SO
DSPIC33EP64MC206T-E/MR
DSPIC33EP64MC506T-E/MR
PIC24EP64MC206T-E/MR
DSPIC33EP64MC204T-E/MV
PIC24EP64MC206-I/MR
DSPIC33EP64MC204-I/MV
DSPIC33EP64MC504-I/MV
PIC24EP64MC204-I/MV
DSPIC33EP64MC204-I/ML
DSPIC33EP64MC204T-I/MV
DSPIC33EP64MC504T-I/MV
PIC24EP64MC204T-I/MV
DSPIC33EP64MC204T-I/ML
DSPIC33EP64MC504T-I/ML
DSPIC33EP64MC204-E/PT
DSPIC33EP64MC504-E/PT
PIC24EP64MC204-E/PT
DSPIC33EP64MC206-E/PT
DSPIC33EP64MC506-E/PT
DSPIC33EP64MC502-I/SP
PIC24EP64MC202-I/SP

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PIC24EP64MC202-I/SS
DSPIC33EP64MC504-I/ML
PIC24EP64MC204-I/ML
DSPIC33EP64MC204-I/PT
DSPIC33EP64MC504-I/PT
PIC24EP64MC204-I/PT
DSPIC33EP64MC206-I/PT
DSPIC33EP64MC506-I/PT
PIC24EP64MC206-I/PT
DSPIC33EP64MC202T-I/MM
DSPIC33EP64MC502T-I/MM
PIC24EP64MC202T-I/MM
DSPIC33EP64MC202T-I/SS
DSPIC33EP64MC502T-I/SS
PIC24EP64MC202T-I/SS
DSPIC33EP64MC202T-I/SO
PIC24EP64MC204T-I/ML
DSPIC33EP64MC204T-I/PT
DSPIC33EP64MC504T-I/PT
PIC24EP64MC204T-I/PT
DSPIC33EP64MC206T-I/PT
DSPIC33EP64MC504-E/MV
PIC24EP64MC204-E/MV
DSPIC33EP64MC204-E/ML
DSPIC33EP64MC504-E/ML
PIC24EP64MC204-E/ML
PIC24EP64MC206-E/PT
DSPIC33EP64MC202-I/MM
DSPIC33EP64MC502-I/MM
PIC24EP64MC202-I/MM
DSPIC33EP64MC202-I/SP
DSPIC33EP64MC506T-I/PT
PIC24EP64MC206T-I/PT
DSPIC33EP64MC202T-E/MM
DSPIC33EP64MC502T-E/MM
PIC24EP64MC202T-E/MM
DSPIC33EP64MC202T-E/SS
DSPIC33EP64MC502T-E/SS
PIC24EP64MC202T-E/SS
DSPIC33EP64MC202T-E/SO
DSPIC33EP64MC502T-E/SO
DSPIC33EP64MC504T-E/MV
PIC24EP64MC204T-E/MV
DSPIC33EP64MC204T-E/ML
DSPIC33EP64MC504T-E/ML
PIC24EP64MC204T-E/ML
DSPIC33EP64GP502-E/SS

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DSPIC33EP64MC204T-H/MV
DSPIC33EP64MC504T-H/MV
PIC24EP64GP204T-H/MV
PIC24EP64MC204T-H/MV
DSPIC33EP64MC206T-H/PT
DSPIC33EP64GP502-H/MM
DSPIC33EP64MC202-H/MM
DSPIC33EP64MC502-H/MM
DSPIC33EP64MC502-H/SP
DSPIC33EP64GP504-H/MV
DSPIC33EP64MC204-H/MV
DSPIC33EP64MC504-H/MV
PIC24EP64GP204-H/MV
PIC24EP64MC204-H/MV
PIC24EP64GP203-H/M5
PIC24EP64MC203-H/M5
DSPIC33EP64GP503-H/M5
DSPIC33EP64MC503-H/M5
DSPIC33EP64MC203-H/M5
DSPIC33EP64MC204-H/PT
DSPIC33EP64MC504-H/PT
DSPIC33EP64MC206-H/PT
DSPIC33EP64MC202T-H/MM
DSPIC33EP64GP504T-H/MV